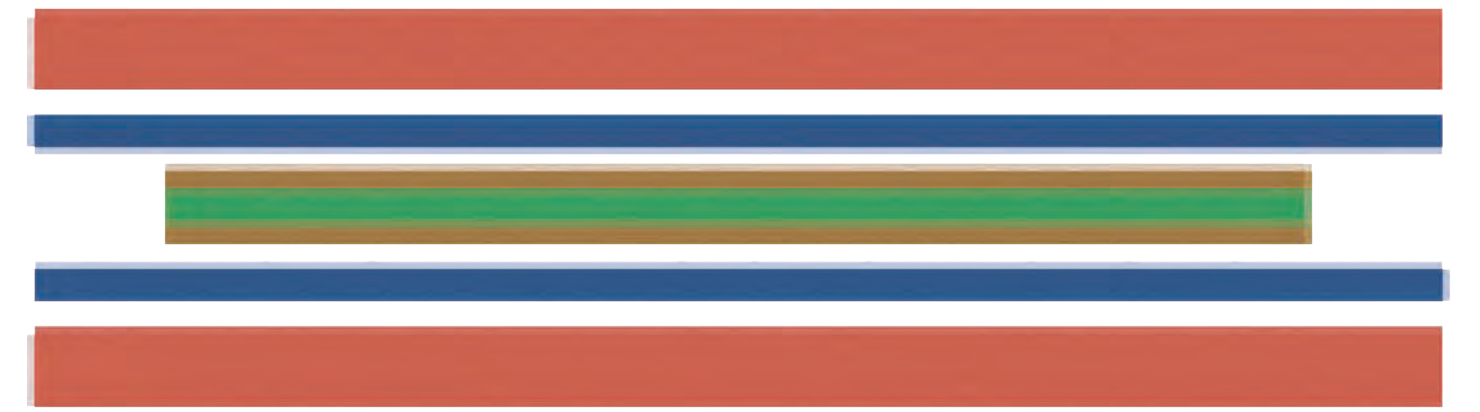


Flex Circuit Applications

Requirements: Surface protection, conformability, easy release.
Products: DAHLAR 9301B, 9610NV, DAHLVIA 9100, NCF 9500 Si-Pad, Si-Pad QL, 9950 TFNP, 9600, DAHLVIA 9119



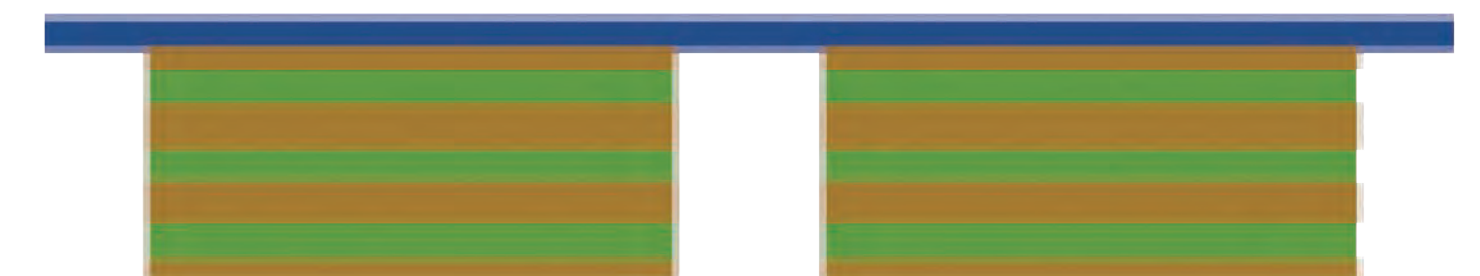
Masslam, CCL, Applications

Requirements: Surface protection, breakdown release.
Products: DAHLAR 9301B, 9000, NCF 9500



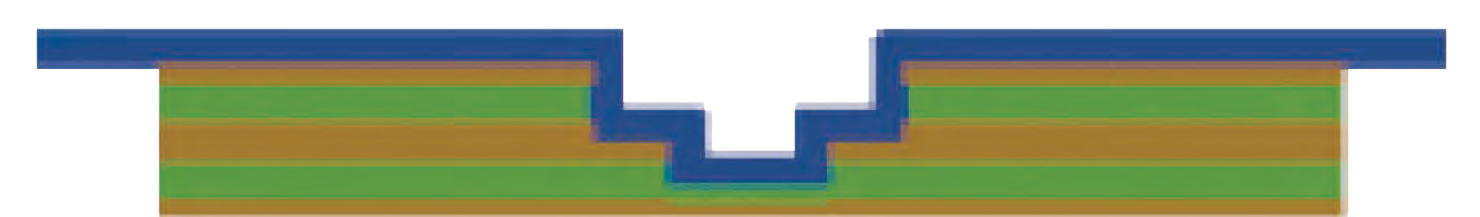
MLB, IVH Applications

Requirements: Surface protection, breakdown release, block resin flow, prevent adhesive "squeeze out" (Flex).
Products: DAHLAR 9301B, 9000, DAHLVIA 9100, 9119, 9173MA, 9139



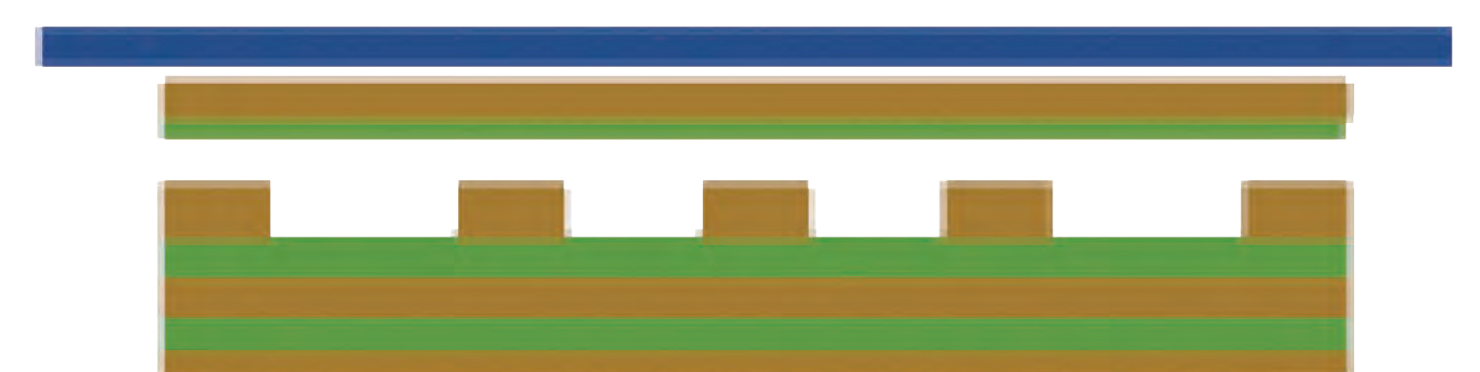
BGA Applications

Requirements: Prevent resin overflow while protecting critical surfaces. Provide ease of release.
Reduce costs with our multilayer technology.
Products: DAHLVIA 9100, 9119, 9173MA, 9139, DAHLAR 9301B, 9900



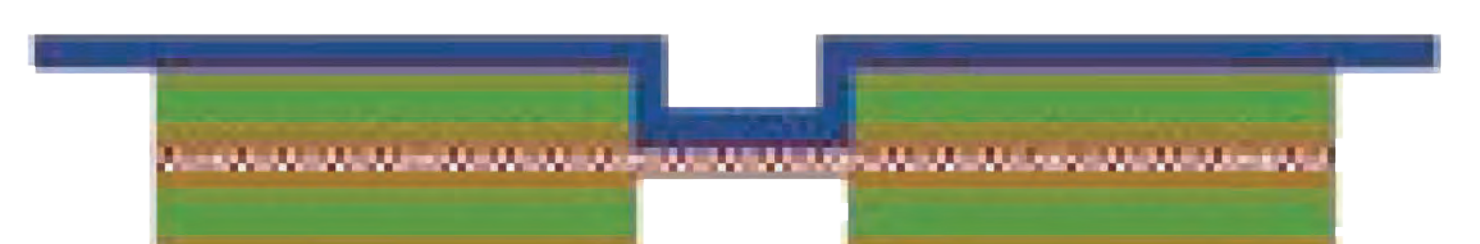
HDI - RCC Applications

Requirements: Eliminate resin voids at laminate surface.
Release at breakdown.
Products: DAHLVIA 9100, 9119, 9173MA, 9139 for conformability / pressure intensification to drive resin



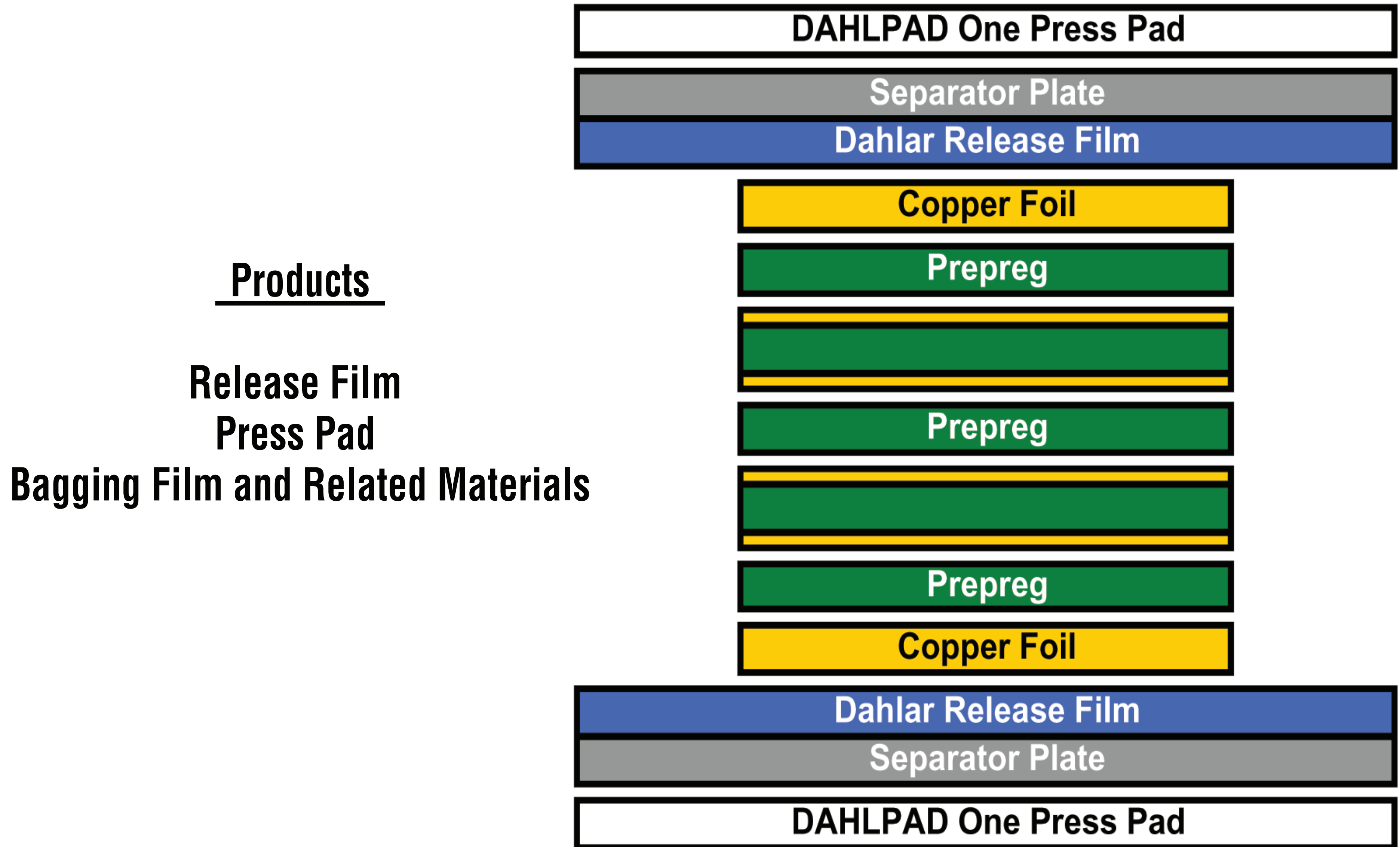
Rigid - Flex Applications

Requirements: Prevent resin overflow, protector for dissimilar surfaces, easy release.
Product: DAHLVIA 9100, 9119, 9173MA, 9139

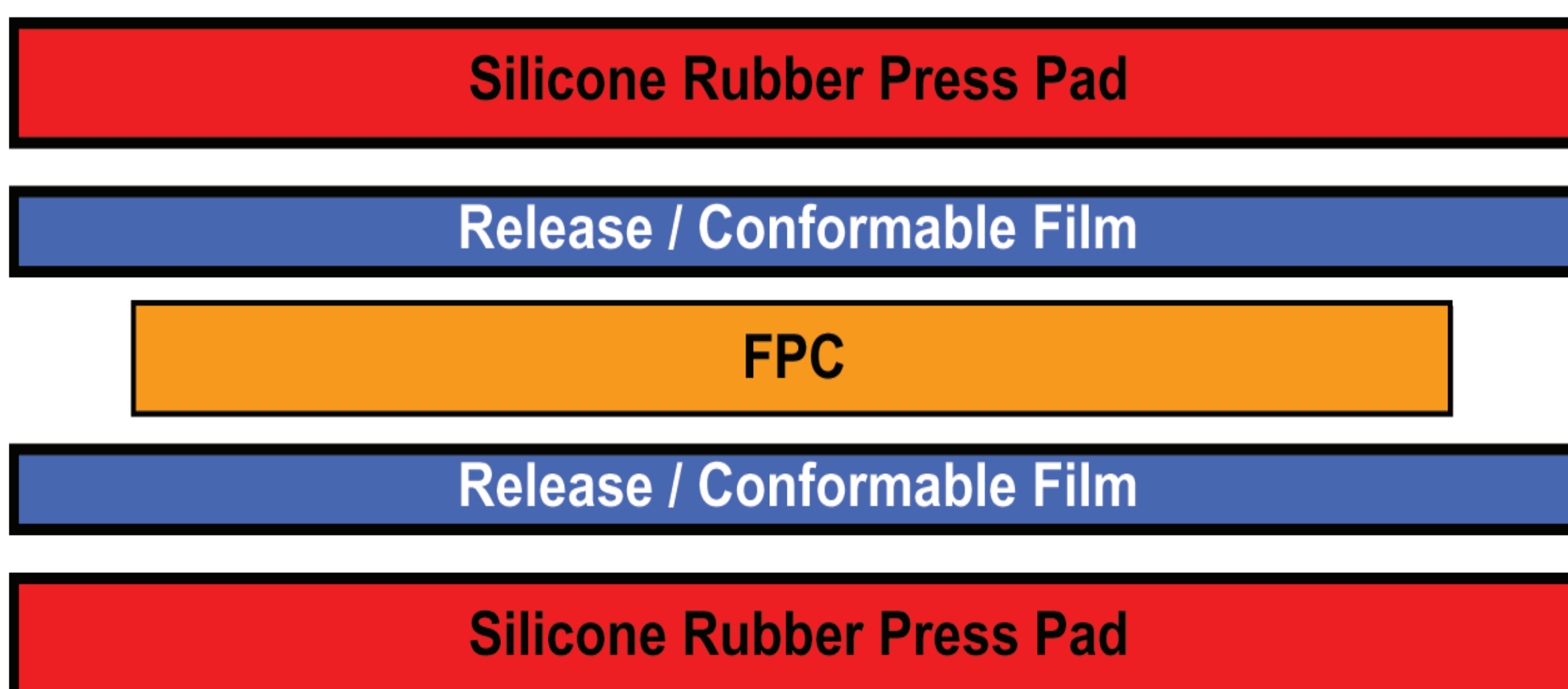


Typical Applications

Rigid PCB Lamination



FPC & Rigid-Flex Lamination



Products

Release Film
Conformable Release Film
Press Pad (Reinforced Silicone Rubber)